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Application Serial No. 10/734,072
Reissue of U.S. Patent No. 6,329,213
Confirmation No. 8908
Filing Date December 10, 2003
Inventor Mark E. Tuttle et al.
Assignee Micron Technology, Inc.
Group Art Unit 2891
Examiner Caridad Everhart
Customer No. 021567
Attorney Docket No. MI40-369
Title: Methods for Forming Integrated Circuits Within Substrates

**PRELIMINARY AMENDMENT FILED IN RESPONSE TO JANUARY 3, 2007 FINAL
OFFICE ACTION UNDER 37 CFR §1.173**

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AMENDMENTS

Responsive to the Final Office Action dated January 3, 2007 in this Reissue application, Applicants amend and remark as follows. Unless otherwise indicated, deletions are [bracketed], additions are underlined to indicate changes relative to the patent.